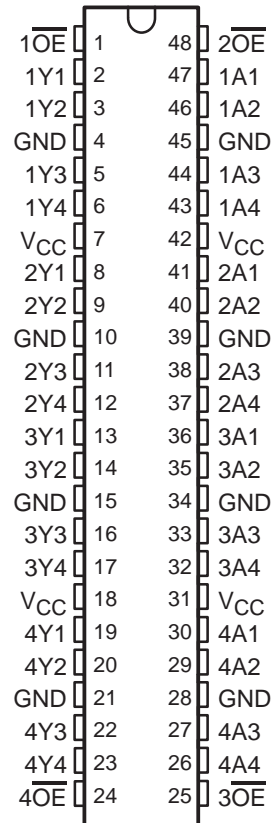


SN54AHC16244, SN74AHC16244 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SCLS327G – MARCH 1996 – REVISED JANUARY 2000

- **Members of the Texas Instruments Widebus™ Family**
- **EPIC™ (Enhanced-Performance Implanted CMOS) Process**
- **Operating Range 2-V to 5.5-V V_{CC}**
- **Distributed V_{CC} and GND Pins Minimize High-Speed Switching Noise**
- **Flow-Through Architecture Optimizes PCB Layout**
- **Latch-Up Performance Exceeds 250 mA Per JESD 17**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)**
- **Package Options Include Plastic Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings**

SN54AHC16244 . . . WD PACKAGE
SN74AHC16244 . . . DGG, DGV, OR DL PACKAGE
(TOP VIEW)



description

The 'AHC16244 devices are 16-bit buffers and line drivers designed specifically to improve the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

These devices can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. They provide true outputs and symmetrical active-low output-enable (\overline{OE}) inputs.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54AHC16244 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74AHC16244 is characterized for operation from -40°C to 85°C .

FUNCTION TABLE
(each 4-bit buffer/driver)

INPUTS		OUTPUT
\overline{OE}	A	Y
L	H	H
L	L	L
H	X	Z



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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 **TEXAS
INSTRUMENTS**

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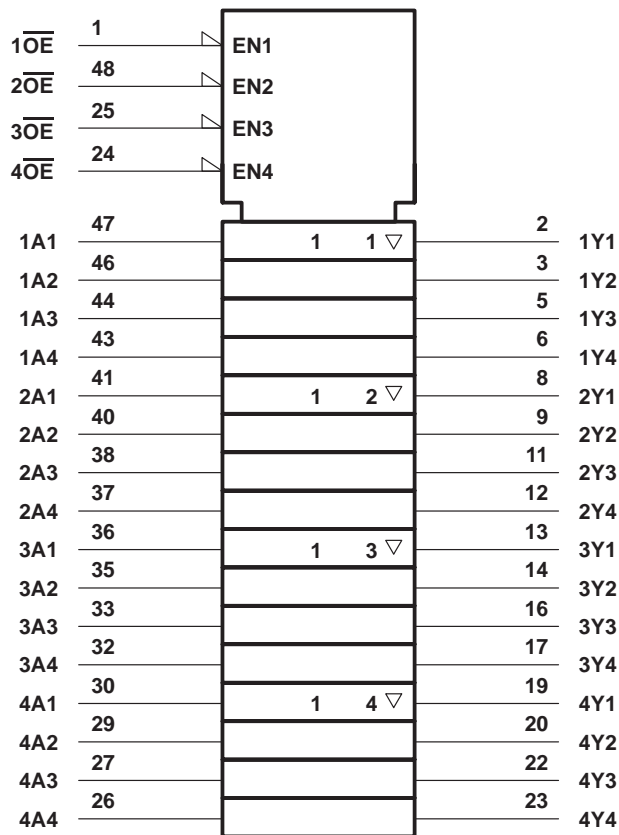
SN54AHC16244, SN74AHC16244

16-BIT BUFFERS/DRIVERS

WITH 3-STATE OUTPUTS

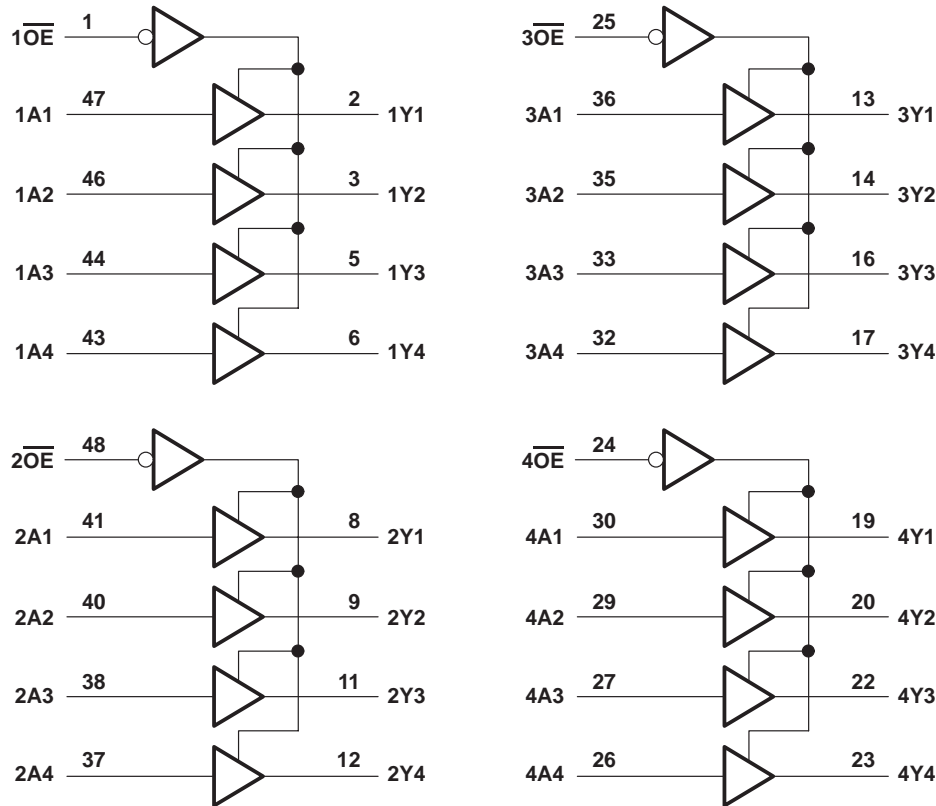
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logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	-0.5 V to 7 V
Input voltage range, V_I (see Note 1)	-0.5 V to 7 V
Output voltage range, V_O (see Note 1)	-0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	-20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	± 20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	± 25 mA
Continuous current through each V_{CC} or GND	± 75 mA
Package thermal impedance, θ_{JA} (see Note 2):	
DGG package	70°C/W
DGV package	58°C/W
DL package	63°C/W
Storage temperature range, T_{stg}	-65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51.

SN54AHC16244, SN74AHC16244

16-BIT BUFFERS/DRIVERS

WITH 3-STATE OUTPUTS

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recommended operating conditions (see Note 3)

		SN54AHC16244		SN74AHC16244		UNIT
		MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage	2	5.5	2	5.5	V
V_{IH}	High-level input voltage	$V_{CC} = 2\text{ V}$		1.5		V
		$V_{CC} = 3\text{ V}$		2.1		
		$V_{CC} = 5.5\text{ V}$		3.85		
V_{IL}	Low-level input voltage	$V_{CC} = 2\text{ V}$		0.5		V
		$V_{CC} = 3\text{ V}$		0.9		
		$V_{CC} = 5.5\text{ V}$		1.65		
V_I	Input voltage	0	5.5	0	5.5	V
V_O	Output voltage	0	V_{CC}	0	V_{CC}	V
I_{OH}	High-level output current	$V_{CC} = 2\text{ V}$		-50		μA
		$V_{CC} = 3.3 \pm 0.3\text{ V}$		-4		
		$V_{CC} = 5 \pm 0.5\text{ V}$		-8		
I_{OL}	Low-level output current	$V_{CC} = 2\text{ V}$		50		μA
		$V_{CC} = 3.3 \pm 0.3\text{ V}$		4		
		$V_{CC} = 5 \pm 0.5\text{ V}$		8		
$\Delta t/\Delta v$	Input transition rise or fall rate	$V_{CC} = 3.3 \pm 0.3\text{ V}$		100		ns/V
		$V_{CC} = 5 \pm 0.5\text{ V}$		20		
T_A	Operating free-air temperature	-55	125	-40	85	$^{\circ}\text{C}$

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V_{CC}	$T_A = 25^{\circ}\text{C}$			SN54AHC16244		SN74AHC16244		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V_{OH}	$I_{OH} = -50\ \mu\text{A}$	2 V	1.9	2	1.9	1.9	V			
		3 V	2.9	3	2.9	2.9				
		4.5 V	4.4	4.5	4.4	4.4				
	$I_{OH} = -4\ \text{mA}$	3 V	2.58		2.48	2.48				
		4.5 V	3.94		3.8	3.8				
V_{OL}	$I_{OL} = 50\ \mu\text{A}$	2 V		0.1	0.1	0.1	V			
		3 V		0.1	0.1	0.1				
		4.5 V		0.1	0.1	0.1				
	$I_{OL} = 4\ \text{mA}$	3 V		0.36	0.5	0.44				
		4.5 V		0.36	0.5	0.44				
I_I	$V_I = V_{CC}$ or GND	0 V to 5.5 V		± 0.1	$\pm 1^*$	± 1	μA			
I_{OZ}	$V_O = V_{CC}$ or GND, V_I (OE) = V_{IL} or V_{IH}	5.5 V		± 0.25	± 2.5	± 2.5	μA			
I_{CC}	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V		4	40	40	μA			
C_i	$V_I = V_{CC}$ or GND	5 V		2		10	pF			
C_o	$V_O = V_{CC}$ or GND	5 V		3.5			pF			

* On products compliant to MIL-PRF-38535, this parameter is not production tested at $V_{CC} = 0\text{ V}$.

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SN54AHC16244, SN74AHC16244 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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**switching characteristics over recommended operating free-air temperature range,
V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T _A = 25°C			SN54AHC16244		SN74AHC16244		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{PLH}	A	Y	C _L = 15 pF	5.8*	8.4*		1*	10*	1	10	ns
t _{PHL}				5.8*	8.4*	1*	10*	1	10		
t _{PZH}	\overline{OE}	Y	C _L = 15 pF	6.6*	10.6*		1*	12.5*	1	12.5	ns
t _{PZL}				6.6*	10.6*	1*	12.5*	1	12.5		
t _{PHZ}	\overline{OE}	Y	C _L = 15 pF	5*	11.5*		1*	12.5*	1	12.5	ns
t _{PLZ}				5*	11.5*	1*	12.5*	1	12.5		
t _{PLH}	A	Y	C _L = 50 pF	8.3	11.9		1	13.5	1	13.5	ns
t _{PHL}				8.3	11.9	1	13.5	1	13.5		
t _{PZH}	\overline{OE}	Y	C _L = 50 pF	9.1	14.1		1	16	1	16	ns
t _{PZL}				9.1	14.1	1	16	1	16		
t _{PHZ}	\overline{OE}	Y	C _L = 50 pF	10.3	14		1	16	1	16	ns
t _{PLZ}				10.3	14	1	16	1	16		
t _{sk(o)}			C _L = 50 pF			1.5**				1.5	ns

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

** On products compliant to MIL-PRF-38535, this parameter does not apply.

**switching characteristics over recommended operating free-air temperature range,
V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T _A = 25°C			SN54AHC16244		SN74AHC16244		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{PLH}	A	Y	C _L = 15 pF	3.9*	6*		1*	7*	1	6.5	ns
t _{PHL}				3.9*	6*	1*	7*	1	6.5		
t _{PZH}	\overline{OE}	Y	C _L = 15 pF	4.7*	7.3*		1*	8.5*	1	8.5	ns
t _{PZL}				4.7*	7.3*	1*	8.5*	1	8.5		
t _{PHZ}	\overline{OE}	Y	C _L = 15 pF	5*	7.2*		1*	8.5*	1	8.5	ns
t _{PLZ}				5*	7.2*	1*	8.5*	1	8.5		
t _{PLH}	A	Y	C _L = 50 pF	5.4	8		1	9	1	8.5	ns
t _{PHL}				5.4	8	1	9	1	8.5		
t _{PZH}	\overline{OE}	Y	C _L = 50 pF	6.2	9.3		1	10.5	1	10.5	ns
t _{PZL}				6.2	9.3	1	10.5	1	10.5		
t _{PHZ}	\overline{OE}	Y	C _L = 50 pF	6.7	9.2		1	10.5	1	10.5	ns
t _{PLZ}				6.7	9.2	1	10.5	1	10.5		
t _{sk(o)}			C _L = 50 pF			1**				1	ns

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

** On products compliant to MIL-PRF-38535, this parameter does not apply.

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SN54AHC16244, SN74AHC16244
16-BIT BUFFERS/DRIVERS
WITH 3-STATE OUTPUTS

SCLS327G – MARCH 1996 – REVISED JANUARY 2000

noise characteristics, $V_{CC} = 5\text{ V}$, $C_L = 50\text{ pF}$, $T_A = 25^\circ\text{C}$ (see Note 4)

PARAMETER	SN74AHC16244			UNIT
	MIN	TYP	MAX	
$V_{OL(P)}$ Quiet output, maximum dynamic V_{OL}		0.5		V
$V_{OL(V)}$ Quiet output, minimum dynamic V_{OL}		-0.2		V
$V_{OH(V)}$ Quiet output, minimum dynamic V_{OH}		4.8		V
$V_{IH(D)}$ High-level dynamic input voltage	3.5			V
$V_{IL(D)}$ Low-level dynamic input voltage			1.5	V

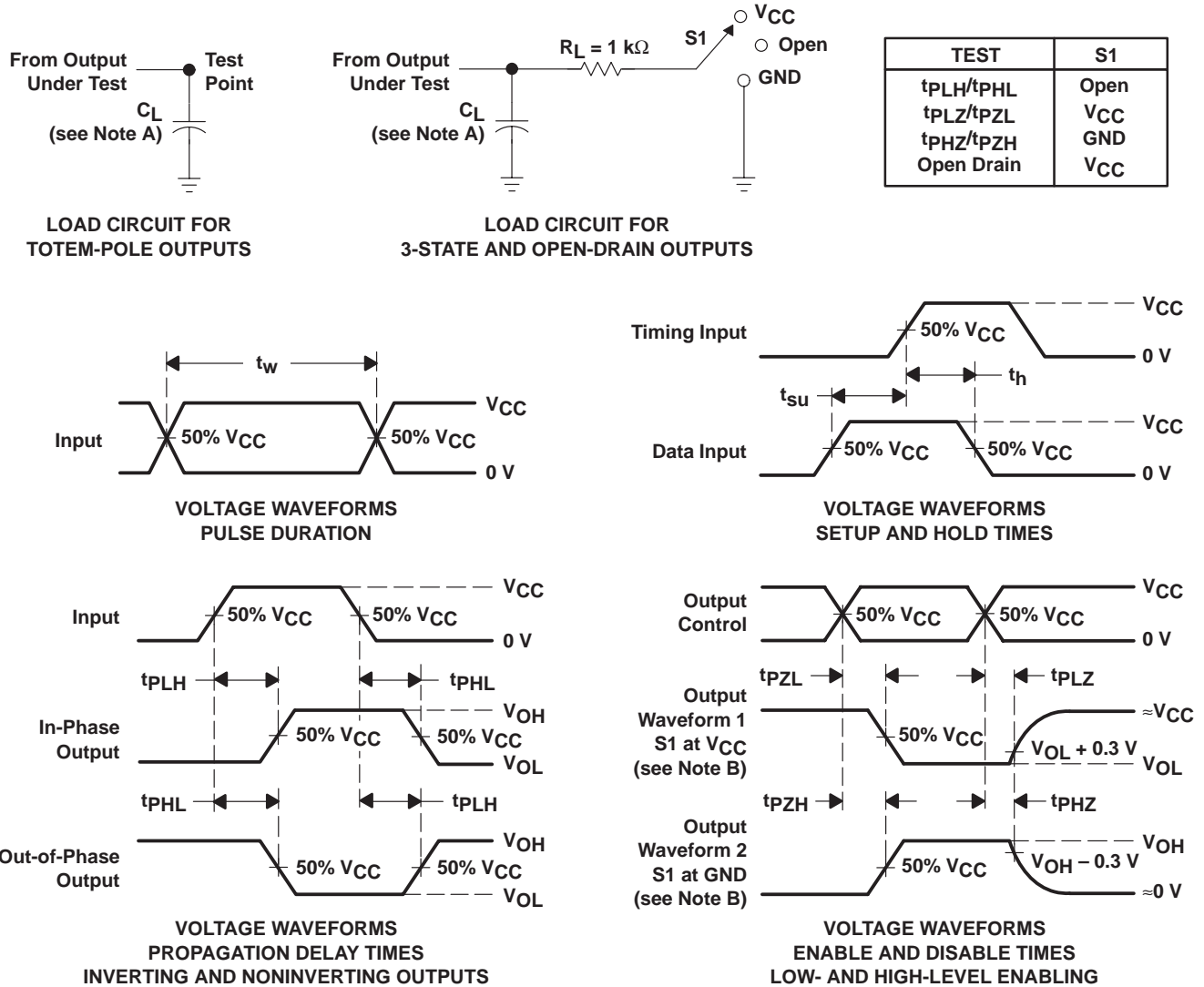
NOTE 4: Characteristics are for surface-mount packages only.

operating characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	TYP	UNIT
C_{pd} Power dissipation capacitance	No load, $f = 1\text{ MHz}$	10.5	pF



PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR $\leq 1\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 3\text{ ns}$, $t_f \leq 3\text{ ns}$.
 D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
74AHC16244DGGRE4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74AHC16244DGVRE4	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC16244DGGR	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC16244DGVR	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC16244DL	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC16244DLG4	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC16244DLR	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC16244DLRG4	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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DGV (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

24 PINS SHOWN



4073251/E 08/00

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
 D. Falls within JEDEC: 24/48 Pins – MO-153
 14/16/20/56 Pins – MO-194

DL (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 D. Falls within JEDEC MO-118

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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